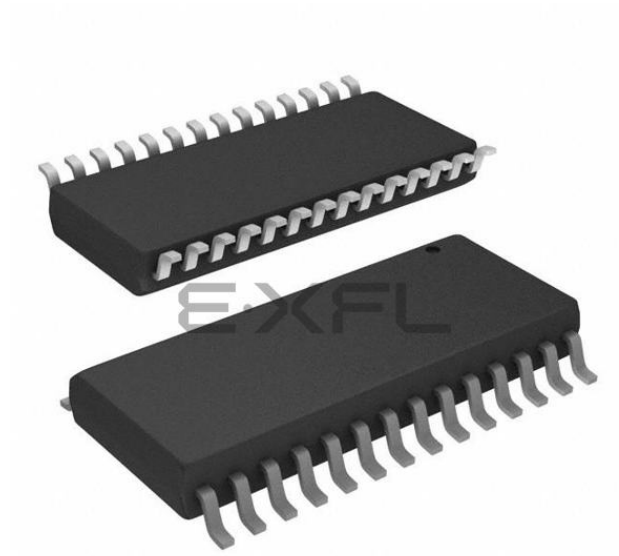

Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	16MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	21
Program Memory Size	4KB (4K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	3.5V ~ 5.5V
Data Converters	A/D 8x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z86e8316sec00tr

PIN DESCRIPTION

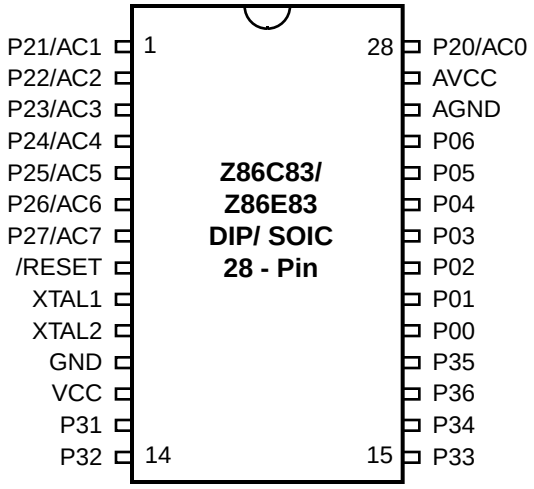

Figure 2. Z86C83 and Standard Mode Z86E83 28-Pin DIP and SOIC Pin Configuration*

Table 1. Z86C83 and Standard Mode Z86E83 28-Pin DIP, SOIC, PLCC Pin Identification*

No	Symbol	Function	Direction
1-7	P21-P27 or AC1-AC7	Port 2, Bit 1-7 Analog In 1-7	Input/Output
8	/RESET	Reset	Input
9	XTAL1	Oscillator Clock	Input
10	XTAL2	Oscillator Clock	Output
11	GND	Ground	
12	V_{CC}	Power	
13-15	P31-P33	Port 3, Bits 1-3	Input
16	P34	Port 3, Bit 4	Output
17	P36	Port 3, Bit 6	Output
18	P35	Port 3, Bit 5	Output
19-25	P00-P06	Port 0, Bits 0-6	Input/Output
26	A_{GND}	Analog Ground	
27	AV_{CC}	Analog Power	
28	P20 or AC0	Port 2, Bit 0 Analog In 0	Input/Output

Note: * DIP and SOIC Pin Description and Configuration are identical.

PIN DESCRIPTION (Continued)

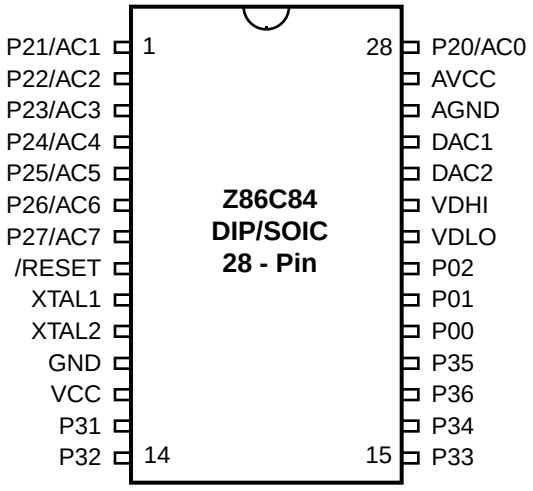

Figure 3. Z86C84 28-Pin DIP and SOIC Pin Configuration

Table 2. Z86C84 28-Pin DIP, SOIC, PLCC Pin Identification*

No	Symbol	Function	Direction
1-7	P21-P27 or AC1-AC7	Port 2, Bit 1-7 Analog In 1-7	Input/Output
8	/RESET	Reset	Input
9	XTAL1	Oscillator Clock	Input
10	XTAL2	Oscillator Clock	Output
11	GND	Ground	
12	V_{CC}	Power	
13-15	P31-P33	Port 3, Bits 1-3	Input
16	P34	Port 3, Bit 4	Output
17	P36	Port 3, Bit 6	Output
18	P35	Port 3, Bit 5	Output
19-21	P00-P02	Port 0, Bits 0-3	Input/Output
22	VDLO	D/A Ref. Volt.,Low	Input
23	VDHI	D/A Ref. Volt.,High	Input
24-25	DAC2-1	D/A Converter	Output
26	A_{GND}	Analog Ground	
27	AV_{CC}	Analog Power	
28	P20 or AC0	Port 2, Bit 0 Analog In 0	Input/Output

Note: * DIP, PLCC and SOIC Pin Description and Configuration are identical

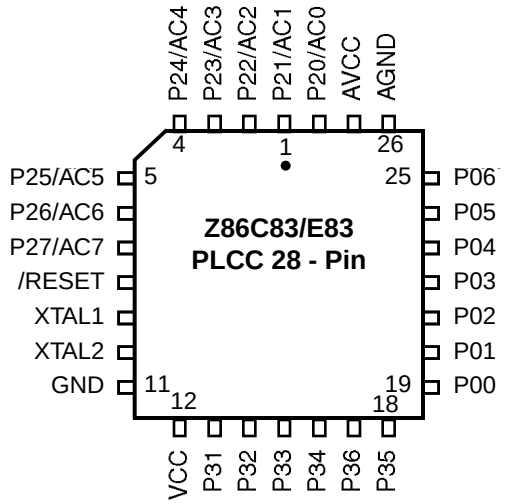

Figure 5. Z86C83 and Standard Mode Z86E83 28-Pin PLCC Pin Configuration

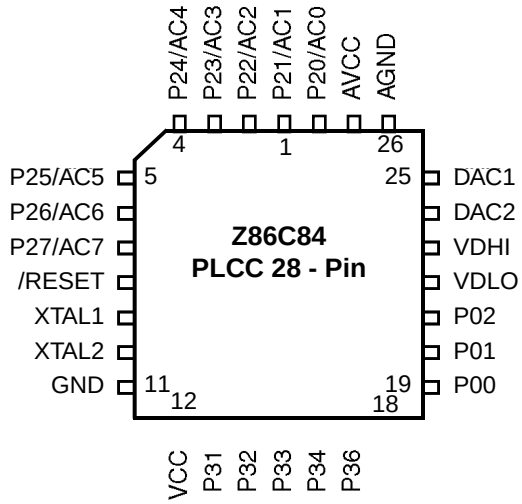

Figure 6. Z86C84 28-Pin PLCC Pin Configuration

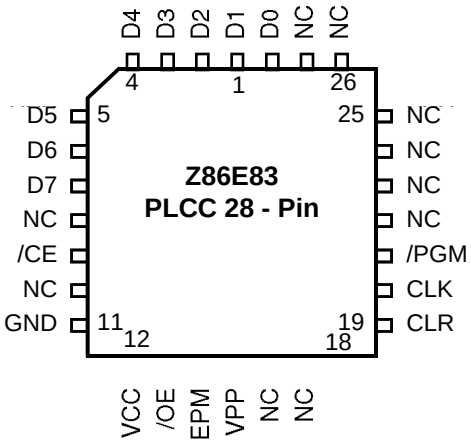

Figure 7. Z86E83 EPROM Programming Mode 28-Pin PLCC Pin Configuration

AC ELECTRICAL CHARACTERISTICS

For Z86C83/C84 Only. Low EMI Mode Only.

				T_A = 0°C to +70°C		T_A = -40° to +105°C			
				4 MHz		4 MHz			
No	**Symbol**	**Parameter**	**V_{CC} [6]**	**Min**	**Max**	**Min**	**Max**	**Units**	**Notes**
1	TpC	Input Clock Period	3.0V	250	DC	250	DC	ns	1,7,8
			5.5V	250	DC	250	DC	ns	1,7,8
2	TrC, TfC	Clock Input Rise & Fall Times	3.0V		25		25	ns	1,7,8
			5.5V		25		25	ns	1,7,8
3	TwC	Input Clock Width	3.0V	125		125		ns	1,7,8
			5.5V	125		125		ns	1,7,8
4	TwTinL	Timer Input Low Width	3.0V	100		100		ns	1,7,8
			5.5V	100		100		ns	1,7,8
5	TwTinH	Timer Input High Width	3.0V	3TpC		3TpC		ns	1,7,8
			5.5V	3TpC		3TpC		ns	1,7,8
6	TpTin	Timer Input Period	3.0V	4TpC		4TpC			1,7,8
			5.5V	4TpC		4TpC			1,7,8
7	TrTin, TfTin	Timer Input Rise & Fall Timer	3.0V		100		100	ns	1,7,8
			5.5V		100		100	ns	1,7,8
8A	TwIL	Int. Request Low Time	3.0V	100		100		ns	1,7,8
			5.5V	70		70		ns	1,7,8
8B	TwIL	Int. Request Low Time	3.0V	3TpC		3TpC		ns	1,3,7,8
			5.5V	3TpC		3TpC		ns	1,3,7,8
9	TwIH	Int. Request Input High Time	3.0V	3TpC		3TpC		ns	1,2,7,8
			5.5V	3TpC		3TpC		ns	1,2,7,8
10	Twsm	Stop-Mode Recovery Width Spec	3.0V	12		12		ns	4,8
			5.5V	12		12		ns	4,8
11	Tost	Oscillator Start-up Time	3.0V		5TpC		5TpC		4,8,9
			5.5V		5TpC		5TpC		4,8,9

Notes:

1. Timing Reference uses 0.7 V_{CC} for a logic 1 and 0.2 V_{CC} for a logic 0.
2. Interrupt request via Port 3 (P33-P31)
3. Interrupt request via Port 3 (P30)
4. SMR-D5 = 1, POR STOP Mode delay is on.
5. Reg. WDTMR
6. The V

PIN FUNCTIONS

EPROM Programming Mode (E83 Only)

D7-D0. *Data Bus.* The data can be read from or written to the EPROM through the data bus.

Clock. *Address Clock.* This pin is a clock input. The internal address counter increases by one with one clock signal.

Clear. *Clear.* (active High). This pin resets the internal address counter at the High Level.

$V_{CC.}$ *Power Supply.* This pin must supply 5V during the EPROM Read Mode and 6V during other modes.

/CE. *Chip Enable* (active Low). This pin is active during EPROM Read, Program, and Program Verify Modes.

/OE. *Output Enable* (active Low). This pin drives the direction of the Data Bus. When this pin is Low, the Data Bus is output, when High, the Data Bus is input.

EPM. *EPROM Program Mode.* This pin controls the different EPROM Program Mode by applying different voltages.

$V_{PP.}$ *Program Voltage.* This pin supplies the program voltage.

/PGM. *Program Mode* (active Low). When this pin is Low, the data is programmed to the EPROM through the Data Bus.

Application Precaution

The production test-mode environment may be enabled accidentally during normal operation if ***excessive noise surges above V_{cc}*** occur on the /RESET pin.

Processor operation of Z8 OTP devices may be affected by excessive noise surges on the VPP, /EPM, /OE pins while the microcontroller is in Standard Mode.

Recommendations for dampening voltage surges in both test and OTP mode include the following:

- Using a clamping diode to /RESET, VPP, /EPM, /OE
- Adding a capacitor to the affected pin

Z86C83, Z86C84, and Standard Mode Z86E83

XTAL1. *Crystal 1* (time-based input). This pin connects a parallel-resonant crystal, ceramic resonator, LC network or an external single-phase clock to the on-chip oscillator input.

XTAL2. *Crystal 2* (time-based output). This pin connects a parallel-resonant crystal, ceramic resonator, LC network to the on-chip oscillator output.

Port 0 P00-P06 (P03-P06 is not available on the Z86C84). Port 0 is a 7-bit, bidirectional, CMOS-compatible I/O port. These seven I/O lines can be nibble programmable as P00-P03 input/output and P04-P06 input/output, separately (Figure 10). All input buffers are Schmitt-triggered and output drivers are push-pull.

Port 0 Auto Latch. (P03-P06 has the Auto Latches permanently enabled). The Auto Latch provides valid CMOS Levels when P03-P06 are selected as inputs and not externally driven. It is impossible to determine if a non-driven input is 1 or 0, however; the Auto Latch will sense the input condition and drive a valid CMOS level, thereby eliminating a floating mode that could cause excessive current.

FUNCTIONAL DESCRIPTION

RESET. (Input, Active Low). This pin initializes the MCU. Reset is accomplished either through Power-On Reset (POR), Watch-Dog Timer (WDT) Reset, or external reset. During POR, and WDT Reset, the internally generated reset is driving the reset pin Low for the POR time. **Any devices driving the reset line must be open-drain to avoid damage from a possible conflict during reset conditions.** Pull-up is provided internally.

After the POR time, /RESET is a Schmitt-triggered input. After the reset is detected, an internal RST signal is latched and held for an internal register count of 18 external clocks, or for the duration of the external reset, whichever is longer. Program execution begins at location 000C (hex), 5-10 TpC cycles after the RST is released. For POR, the reset output time is T_{POR}.

Program Memory. C83/C84/E83/E84 can address up to 4 KB of internal Program Memory (Figure 15). The first 12 bytes of program memory are reserved for the interrupt vectors. These locations contain six 16-bit vectors that correspond to the six available interrupts. Bytes 13 to 4095 consist of on-chip, mask-programmed ROM.

ROM Protect. The 4 KB of Program Memory is mask programmable. A ROM protect feature will prevent dumping of the ROM contents from an external program outside the ROM.

Expanded Register File. The register file has been expanded to allow for additional system control registers and for mapping of additional peripheral devices and input/output ports into the register address area. The Z8 register address space R0 through R15 is implemented as 16 groups of 16 registers per group (Figure 16). These register banks are known as the Expanded Register File (ERF). Bits 3-0 of the Register Pointer (RP) select the active ERF bank. Bits 7-4 of register RP select the working register group (Figure 16). Four system configuration registers reside in the ERF address space in Bank F and eight registers reside in Bank C. The rest of the ERF addressing space is not physically implemented, and is open for future expansion.

Note: When using Zilog's Cross Assembler version 2.1 or earlier, use the LD RP, #0X instruction rather than the SRP #0X instruction to access the ERF.

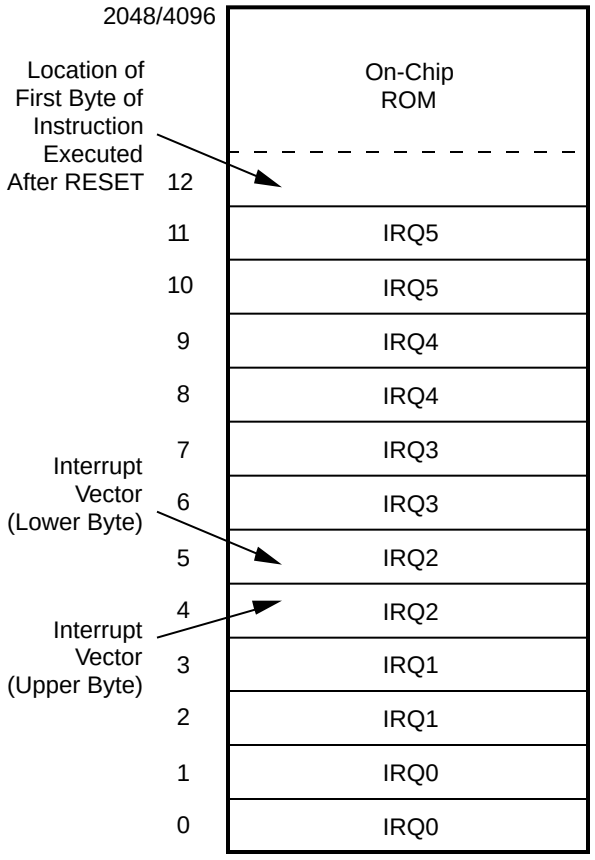

Figure 15. Program Memory Map

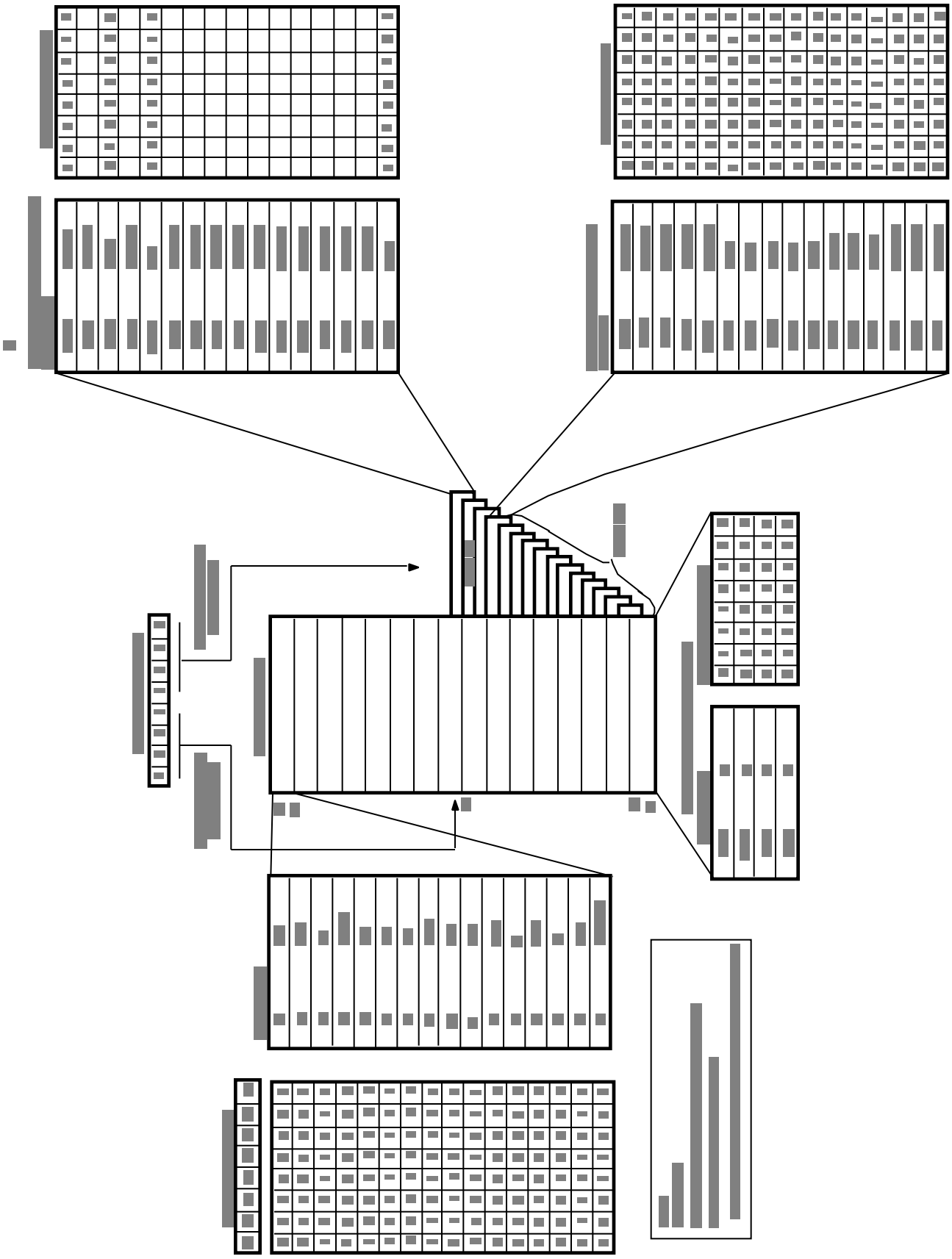

Figure 16. Expanded Register File Architecture

FUNCTIONAL DESCRIPTION (Continued)

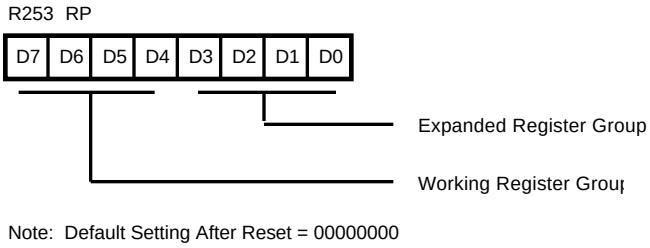

Figure 17. Register Pointer Register

Register File. The Register File consists of three I/O port registers, 237 general-purpose registers, 15 control and status registers, and four system configuration registers in the Expanded Register Group (Figure 16). The instructions can access registers directly or indirectly through an 8-bit address field. This allows a short 4-bit register address using the Register Pointer (Figure 18). In the 4-bit mode, the Register File is divided into 16 working register groups, each occupying 16 continuous locations. The Register Pointer (Figure 17) addresses the starting location of the active working-register group.

Note: Register Bank E0-EF is only accessed either as working registers or through indirect addressing modes.

CAUTION: D4 of Control Register P01M (R251) must be 0.

R254. The C83/C84/E83 has one extra general-purpose register located at FEH (R254).

Stack. The C83/C84/E83 has an 8-bit Stack Pointer (R255) used for the internal stack that resides within the 236 general-purpose registers. Register R254 cannot be used for stack.

General-Purpose Registers (GPR). These registers are undefined after the device is powered up. The registers keep their last value after any reset, as long as the reset occurs in the V_{CC} voltage-specified operating range. It will not keep its last state from a V_{LV} reset if the V_{CC} drops below 1.8V. This includes Register R254.

Note: Register Bank E0-EF is only accessed either as working register or through indirect addressing modes.

RAM Protect. The upper portion of the RAM's address spaces %80F to %EF (excluding the control registers) are protected from writing. The user activates this feature from the internal ROM code to turn off/on the RAM Protect by loading either a 0 or 1 into the Interrupt Mask (IMR) register, bit D6. A 1 in D6 enables RAM Protect.

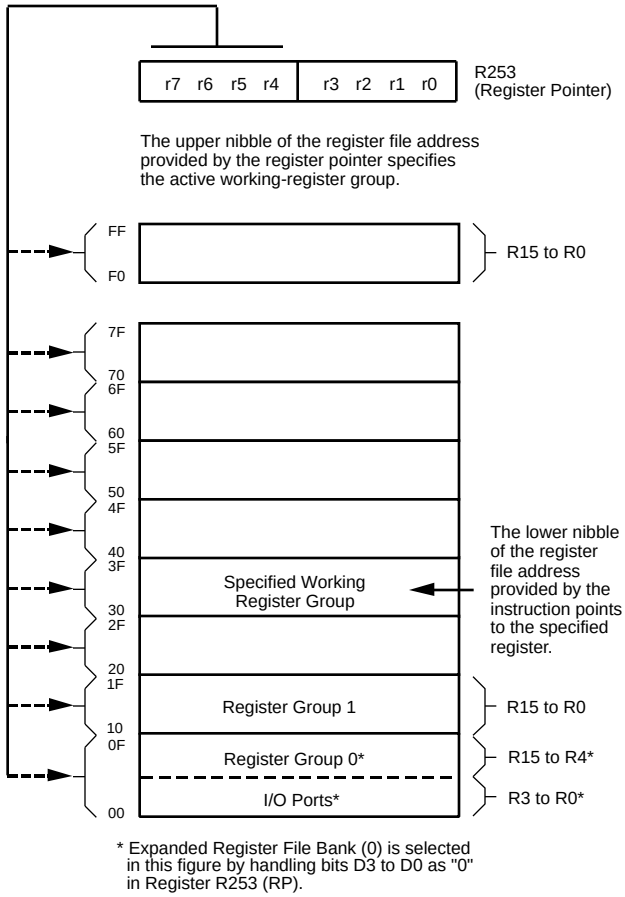

Figure 18. Register Pointer

FUNCTIONAL DESCRIPTION (Continued)

Figure 27 shows the input circuit of the ADC. When conversion starts the analog input voltage is connected to the MSB and LSB flash converter inputs as shown in the Input Impedance CKT diagram. Effectively, shunting 31 parallel internal resistance of the analog switches and simultaneously charging 31 parallel 0.5 pF capacitors, which is equivalent to seeing a 400 Ohms input impedance in parallel with a 16 pF capacitor. Other input stray capacitance adds about 10 pF to the input load. For input source resistances up to 2 Kohms can be used under normal operating condition without any degradation of the input settling time. For larger input source resistance, increasing conversion cycle time or adding a capacitor to the input may be required to compensate the input settling time problem.

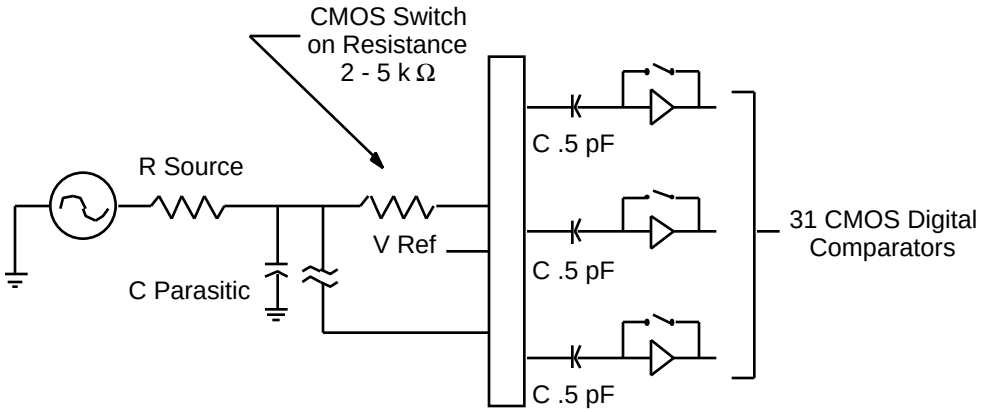

Figure 27. Input Impedance of ADC

Typical Z8 A/D Conversion Sequence

3. Set the register pointer to Extended Bank (C), that is, SRP #%0C instruction.

4. Next, set ADE flag by loading ADC1 Control Register Bank (C) Register 9, bit 7. Also, load bits 0-4 of this same register to select a AV_{CC} or A_{GND} offset value. A precision voltage divider connected to the A/D resistive ladder can offset conversion dynamic range to specified limits within the AV_{CC} and A_{GND} limits. By loading Bank (C) Register 9, bits 0-4, with the appropriate value it is possible to select from these groups:

   a. No Offset. The Converter Dynamic range is from 0V to 5.0V for AV_{CC} = 5.0V.

   b. 35 Percent A_{GND} Offset. The Converter Dynamic range is 1.75V - 5.0V for AV_{CC} = 5.0V.

   c. 50 Percent A_{GND} Offset. The Converter Dynamic range is 2.5V - 5.0V for AV_{CC} = 5.0V.

5. Select one of the eight A/D inputs for conversion by loading Bank (C) Register 8 with the desired attributes: Bits 0 - 2 select an A/D input, bits 3 and 4 select A/D conversion (or digital port I/O).

6. Set Bank (C) Register 8, bit 3 to enable A/D conversion. (This flag can be set concurrently with step 3.) This flag is automatically reset when the A/D conversion is completed, so a bit test can be performed to determine A/D readiness if necessary.

7. Read the A/D result in Bank (C) Register A. Please note that the A/D result is not valid (indeterminate) unless ADE flag (Register 9, bit 7) was previously set, otherwise A/D converter output is tri-stated.

Digital-to-Analog Converters

The Z86C84 has two Digital-to-Analog Converters (DACs). Each DAC is an 8-bit resistor string, with a programmable 0.25X, 0.5X, or 1X gain output buffer. The DAC output voltage settles after the internal data is latched into the DAC Data register. The top and bottom ends of the resistor ladder are register-selected to be connected to either the analog supply rails, AV_{CC} and A_{GND}, or two externally-provided reference voltages, VDHI and VDLO. External references are recommended to explicitly set the DAC output limits. Since the gain stage cannot drive to the supply rails, VDHI and VDLO must be within ranges shown in the specifications. If either reference approaches the analog supply rails, the output will be unable to span the reference voltage range. The externally provided reference voltages should not exceed the supply voltages. The DAC outputs are latch-up protected and can drive output loads (Figure 28).

Note: The AV_{CC} must be the same value as V_{CC} and A_{GND} must be the same value as GND

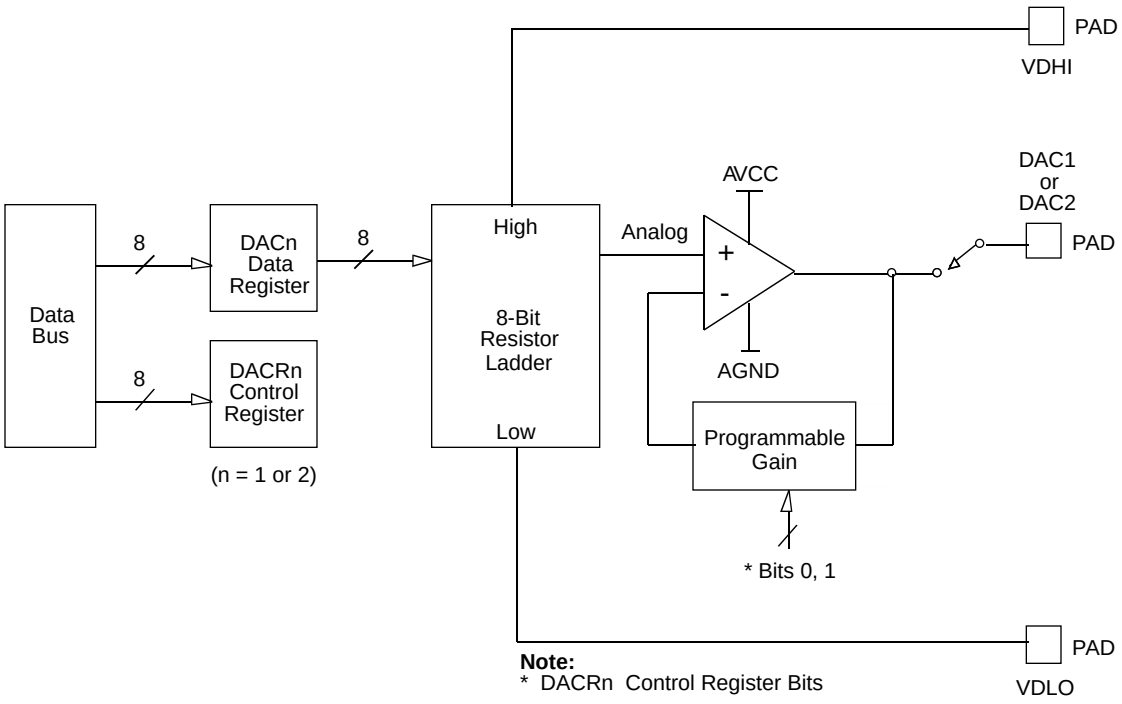

Figure 28. DAC Block Diagram